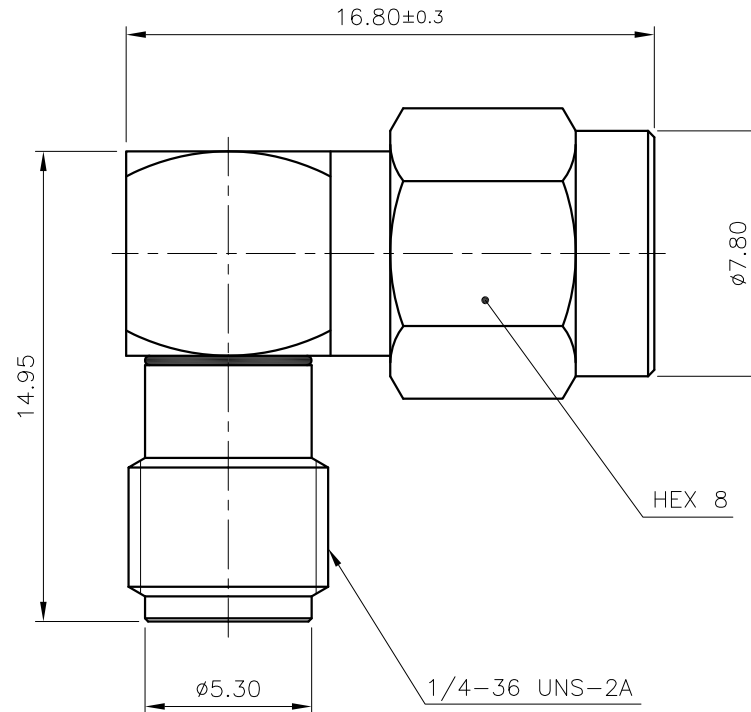


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	I.C.KIM	S.J.YOUN	2008.12.08.
1	작업성 개선으로 인한 A+B/은뎡 은납링 적용 구조 변경	S.Y.EUN	I.C.KIM	2021.10.29.



ELECTRICAL SPEC

1. Impedance : 50ohm (Nominal)
2. Frequency range : DC ~ 6.0GHz
3. VSWR (max) : 1.25 : 1
4. Insertion Loss (Min) : -0.2dB

9	SPRING RING	1	SUS304	부동태 처리	DSR00002-5/1 (R2001)
8	COVER	1	MBsBD	Gold Plate	DCO00039-5/1 (LB004)
7	COUPLING CAP	1	MBsBD	Gold Plate	DCU00005-5/1 (K2001)
6	INSULATOR	1	TEFLON		DIN01255-N/1
5	INSULATOR	1	TEFLON		DIN01453-N/1
4	GASKET	1	SILICONE RUB		DGK00004-N/1 (G2001)
3	CONTACT	1	BeCu	Gold Plate	DCT01819-5/1
2	CONTACT	1	MBsBD	Gold Plate	DCT01818-5/1
1	1-2 BODY (B)	1	MBsBD	Gold Plate	DBB002280-1/2
1	1-1 BODY (A)	1	MBsBD	Gold Plate	DBB002279-1/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2021. 10. 29.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY I.C.KIM			
MATERIAL _____		CHECKED BY		TITLE SMA-Male/Female R/A ADAPTOR	
		DRAWN BY	S.Y.EUN		
FINISH _____		SCALE 4/1	UNIT mm	 A4	DWG NO. AD00385-7/1
					REVISION 1